

Solid Tantalum Chip Capacitors

MICROTAN® Leadframeless Molded



FEATURES

- Small sizes include 0603 and 0402 footprint
- Lead (Pb)-free L-shaped face-down terminations
- 8 mm tape and reel packaging available per EIA-481 and reeling per IEC 60286-3 7" [178 mm] standard
- Mounting: Surface mount
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
GREEN
(5-2008)

PERFORMANCE CHARACTERISTICS

Operating Temperature: - 55 °C to + 85 °C
(to + 125 °C voltage derating)

Capacitance Range: 1 µF to 330 µF

Capacitance Tolerance: ± 20 % standard, ± 10 % available

Voltage Range: 2.5 V_{DC} to 50 V_{DC}

ORDERING INFORMATION

298D TYPE	335 CAPACITANCE	X0 CAPACITANCE TOLERANCE	010 DC VOLTAGE RATING AT + 85 °C	M CASE CODE	2 TERMINATION	T REEL SIZE AND PACKAGING
	This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow.	X0 = ± 20 % X9 = ± 10 %	This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V).	See Ratings and Case Codes table	2 = 100 % tin 4 = Gold plated	T = Tape and reel 7" [178 mm] reel

Note

- Preferred tolerance and reel sizes are in bold.
We reserve the right to supply higher voltage ratings and tighter capacitance tolerance capacitors in the same case size.
Voltage substitutions will be marked with the higher voltage rating.

DIMENSIONS in inches [millimeters]

CASE CODE	L	W	H (MAX.)	P1	P2 (REF.)	C
K	0.039 ± 0.008 [1.0 ± 0.2]	0.02 ± 0.008 [0.5 ± 0.2]	0.024 [0.6]	0.01 ± 0.004 [0.25 ± 0.1]	0.02 [0.5]	0.015 ± 0.004 [0.38 ± 0.1]
M	0.063 ± 0.008 [1.60 ± 0.2]	0.033 ± 0.008 [0.85 ± 0.2]	0.035 [0.9]	0.020 ± 0.004 [0.50 ± 0.1]	0.024 [0.60]	0.024 ± 0.004 [0.60 ± 0.1]
R	0.081 ± 0.006 [2.06 ± 0.15]	0.053 ± 0.006 [1.35 ± 0.15]	0.062 [1.57]	0.020 ± 0.004 [0.51 ± 0.1]	0.043 [1.1]	0.035 ± 0.004 [0.90 ± 0.1]
P	0.094 ± 0.004 [2.4 ± 0.1]	0.057 ± 0.004 [1.45 ± 0.1]	0.047 [1.2]	0.020 ± 0.004 [0.50 ± 0.1]	0.057 [1.40]	0.035 ± 0.004 [0.90 ± 0.1]
Q	0.126 ± 0.008 [3.2 ± 0.2]	0.063 ± 0.008 [1.6 ± 0.2]	0.039 [1.0]	0.031 ± 0.004 [0.80 ± 0.1]	0.063 [1.60]	0.047 ± 0.004 [1.20 ± 0.1]
A	0.126 ± 0.008 [3.2 ± 0.2]	0.063 ± 0.008 [1.6 ± 0.2]	0.071 [1.8]	0.031 ± 0.004 [0.80 ± 0.1]	0.063 [1.60]	0.047 ± 0.004 [1.20 ± 0.1]
B	0.138 ± 0.008 [3.5 ± 0.2]	0.112 ± 0.008 [2.8 ± 0.2]	0.08 [2.0]	0.031 ± 0.008 [0.80 ± 0.2]	0.077 [1.95]	0.094 ± 0.004 [2.4 ± 0.1]



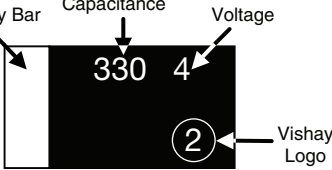


RATINGS AND CASE CODES

μF	2.5 V	4 V	6.3 V	10 V	16 V	20 V	25 V	35 V	50 V
1.0			K	K	K/M		M/R		P
1.5				M					
2.2			K/M	K/M	M			P	
3.3			M	M					
4.7		K	M	M/P	M/P	P	P		
10		K/M	K ⁽¹⁾ /M	M	R		A		
15		K	M	M					
22	K	K/M	M	M					
33		M	M	P					
47	M	M	R/P/A	P					
100		P	P/Q/A						
220	P	P/Q							
330			B						

Note

(1) Rating in development, contact factory for availability.

MARKING

		VOLTAGE CODE		CAPACITANCE CODE	
		V	CODE	CAP, μF	CODE
M-Case  K-Case  B-Case 		2.5	e	0.68	\bar{w}
		4.0	G	1.0	A
		6.3	J	2.2	J
		10	A	3.3	N
		16	C	4.7	S
		20	D	6.8	W
		25	E	10	α
		35	V	15	e
		50	T	22	j
				33	n
P, R-Case  A, Q-Case 				47	s
				68	w
				100	\bar{A}
				150	\bar{E}
				220	\bar{J}



STANDARD RATINGS						
CAPACITANCE (μ F)	CASE CODE	PART NUMBER	MAX. DC LEAKAGE AT + 25 °C (μ A)	MAX. DF AT + 25 °C (%)	MAX. ESR AT + 25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I_{RMS} (A)
2.5 V _{DC} AT + 85 °C; 1.6 V _{DC} AT + 125 °C						
22	K	298D226X02R5K(2)T	10	40	20.00	0.027
47	M	298D476X02R5M(2)T	2.4	20	4.00	0.080
220	P	298D227X02R5P(2)T	11	30	3.00	0.122
4 V _{DC} AT + 85 °C; 2.7 V _{DC} AT + 125 °C						
4.7	K	298D475X0004K(2)T	0.5	15	20.00	0.027
10	K	298D106X0004K(2)T	4.0	50	20.00	0.027
10	M	298D106(1)004M(2)T	0.5	8	5.00	0.071
15	K	298D156X0004K(2)T	10	50	20.00	0.027
22	K	298D226X0004K(2)T	25	40	20.00	0.027
22	M	298D226X0004M(2)T	0.9	15	4.00	0.080
33	M	298D336X0004M(2)T	2.6	30	4.00	0.080
47	M	298D476X0004M(2)T	3.8	40	7.50	0.080
100	P	298D107X0004P(2)T	4.0	30	2.00	0.100
220	P	298D227(1)004P(2)T	17.6	30	3.00	0.122
220	Q	298D227X0004Q(2)T	88	80	15.00	0.061
6.3 V _{DC} AT + 85 °C; 4 V _{DC} AT + 125 °C						
1.0	K	298D105X06R3K(2)T	0.5	6	20.00	0.027
2.2	K	298D225X06R3K(2)T	0.5	8	20.00	0.027
2.2	M	298D225(1)6R3M(2)T	0.5	10	5.00	0.070
3.3	M	298D335(1)6R3M(2)T	0.5	8	6.00	0.090
4.7	M	298D475(1)6R3M(2)T	0.5	8	3.00	0.090
10	K ⁽¹⁾	298D106X06R3K(2)T	10	50	20.00	0.027
10	M	298D106X06R3M(2)T	0.6	8	5.00	0.071
15	M	298D156X06R3M(2)T	1.0	20	7.00	0.060
22	M	298D226X06R3M(2)T	2.8	20	5.50	0.067
33	M	298D336X06R3M(2)T	4.2	30	7.50	0.058
47	R	298D476X06R3R2T	3.0	25	3.00	0.122
47	P	298D476X06R3P(2)T	3.0	22	3.00	0.122
47	A	298D476X06R3A(2)T	3.0	10	2.00	0.150
100	P	298D107X06R3P(2)T	6.3	30	2.00	0.150
100	Q	298D107X06R3Q(2)T	6.3	30	1.10	0.220
100	A	298D107X06R3A(2)T	6.3	20	1.00	0.270
330	B	298D337X06R3B(2)T	104	30	1.00	0.290
10 V _{DC} AT + 85 °C; 7 V _{DC} AT + 125 °C						
1.0	K	298D105X0010K(2)T	0.5	6	20.00	0.027
1.5	M	298D155(1)010M(2)T	0.5	6	14.00	0.040
2.2	K	298D225X0010K(2)T	0.5	8	15.00	0.027
2.2	M	298D225X0010M(2)T	0.5	10	10.00	0.050
3.3	M	298D335(1)010M(2)T	0.5	8	6.00	0.090
4.7	M	298D475(1)010M(2)T	0.5	6	5.00	0.071
4.7	P	298D475(1)010P(2)T	0.5	6	4.00	0.106

Notes

- Part number definitions:
 - (1) Tolerance: For 10 % tolerance, specify "X9"; for 20 % tolerance, change to "X0"
 - (2) Termination: For 100 % tin specify "2", for gold plated specify "4"
- (1) Rating in development, contact factory for availability



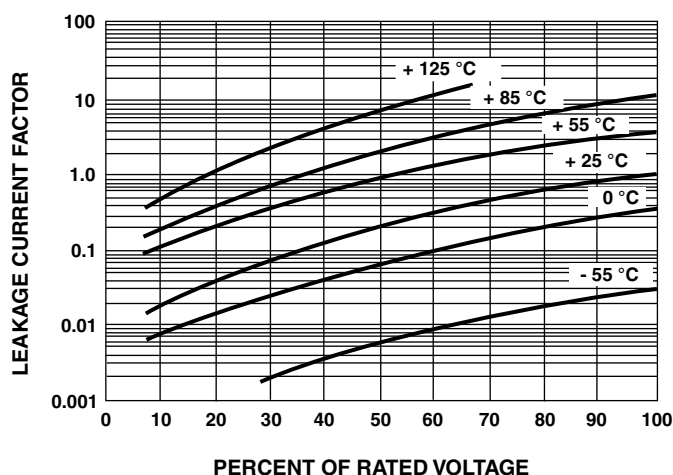
STANDARD RATINGS						
CAPACITANCE (μ F)	CASE CODE	PART NUMBER	MAX. DC LEAKAGE AT + 25 °C (μ A)	MAX. DF AT + 25 °C (%)	MAX. ESR AT + 25 °C 100 kHz (Ω)	MAX. RIPPLE 100 kHz I_{RMS} (A)
10 V _{DC} AT + 85 °C; 7 V _{DC} AT + 125 °C						
10	M	298D106X0010M(2)T	1.0	20	7.50	0.058
15	M	298D156X0010M(2)T	1.5	30	7.50	0.058
22	M	298D226X0010M(2)T	22.0	40	10.00	0.050
33	P	298D336X0010P(2)T	3.3	20	4.00	0.150
47	P	298D476X0010P(2)T	4.7	22	3.00	0.122
16 V _{DC} AT + 85 °C; 10 V _{DC} AT + 125 °C						
1.0	K	298D105X0016K(2)T	3.0	10	20.00	0.027
1.0	M	298D105(1)016M(2)T	0.5	6	12.00	0.045
2.2	M	298D225(1)016M(2)T	0.5	10	12.00	0.045
4.7	M	298D475X0016M(2)T	0.8	8	6.00	0.060
4.7	P	298D475(1)016P(2)T	0.8	6	4.00	0.106
10	R	298D106(1)016R(2)T	1.6	8	8.00	0.075
20 V _{DC} AT + 85 °C; 13 V _{DC} AT + 125 °C						
4.7	P	298D475(1)020P(2)T	1.0	6	4.00	0.106
25 V _{DC} AT + 85 °C; 17 V _{DC} AT + 125 °C						
1.0	M	298D105X0025M(2)T	0.5	6	10.00	0.050
1.0	R	298D105(1)025R(2)T	0.5	6	10.00	0.067
4.7	P	298D475(1)025P(2)T	1.2	6	4.00	0.106
10	A	298D106X0025A(2)T	2.5	10	3.50	0.146
35 V _{DC} AT + 85 °C; 23 V _{DC} AT + 125 °C						
2.2	P	298D225X0035P(2)T	0.8	8	8.00	0.075
50 V _{DC} AT + 85 °C; 33 V _{DC} AT + 125 °C						
1.0	P	298D105X0050P(2)T	0.5	8	8.00	0.075

Notes

- Part number definitions:
 - Tolerance: For 10 % tolerance, specify "X9"; for 20 % tolerance, change to "X0"
 - Termination: For 100 % tin specify "2", for gold plated specify "4"
- Rating in development, contact factory for availability

**CAPACITORS PERFORMANCE CHARACTERISTICS**

ELECTRICAL PERFORMANCE CHARACTERISTICS				
ITEM	PERFORMANCE CHARACTERISTICS			
Category Temperature Range	- 55 °C to + 85 °C (to + 125 °C with voltage derating)			
Capacitance Tolerance	± 20 %, ± 10 %, tested via bridge method, at 25 °C, 120 Hz			
Dissipation Factor (at 120 Hz)	Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 120 Hz.			
ESR (100 kHz)	Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 100 kHz.			
Leakage Current	After application of rated voltage applied to capacitors for 5 min using a steady source of power with 1 k Ω resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in Standard Ratings table. Note that the leakage current varies with temperature and applied voltage. See graph below for the appropriate adjustment factor.			
Reverse Voltage	Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at + 25 °C 5 % of the DC rating at + 85 °C 1 % of the DC rating at + 125 °C Vishay does not recommend intentional or repetitive application of reverse voltage			
Temperature Derating	If capacitors are to be used at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors: 1.0 at + 25 °C 0.9 at + 85 °C 0.4 at + 125 °C			
Operating Temperature	+ 85 °C RATING		+ 125 °C RATING	
	RATED VOLTAGE (V)	SURGE VOLTAGE (V)	RATED VOLTAGE (V)	SURGE VOLTAGE (V)
	2.5	3.3	1.7	2.2
	4.0	5.2	2.7	3.4
	6.3	8.0	4.0	5.0
	10	13	7.0	8.0
	16	20	10	12
	20	26	13	16
	25	32	17	20
	35	46	23	28
	50	65	33	40

TYPICAL LEAKAGE CURRENT FACTOR RANGE**Notes**

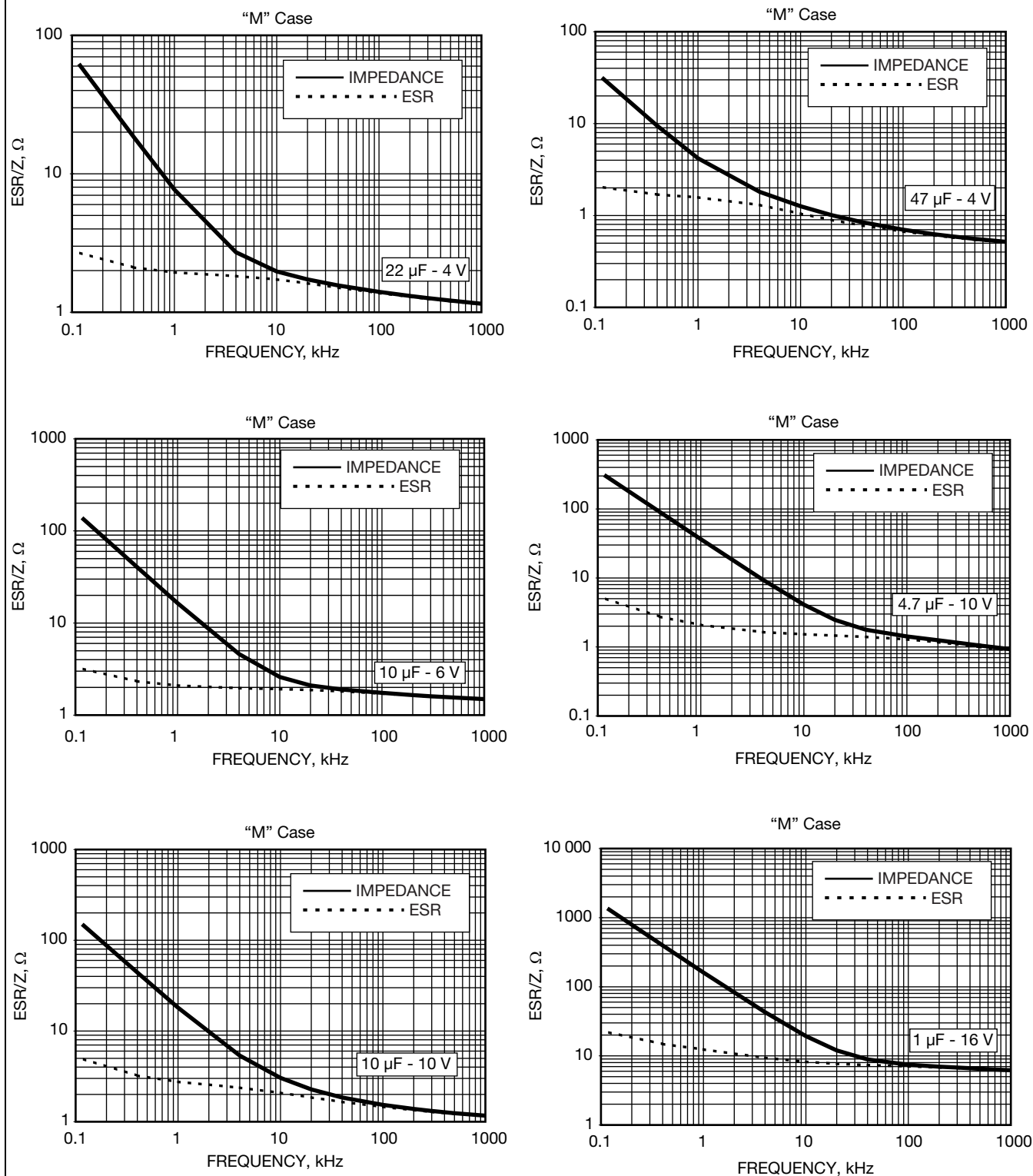
- At + 25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table
- At + 85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table
- At + 125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table

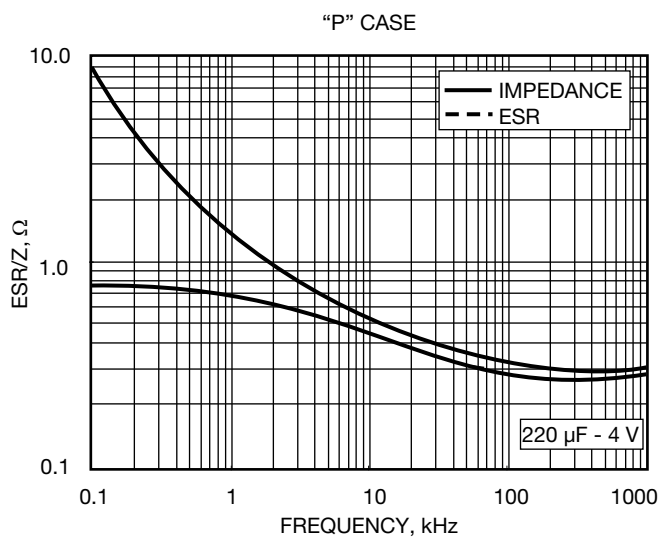
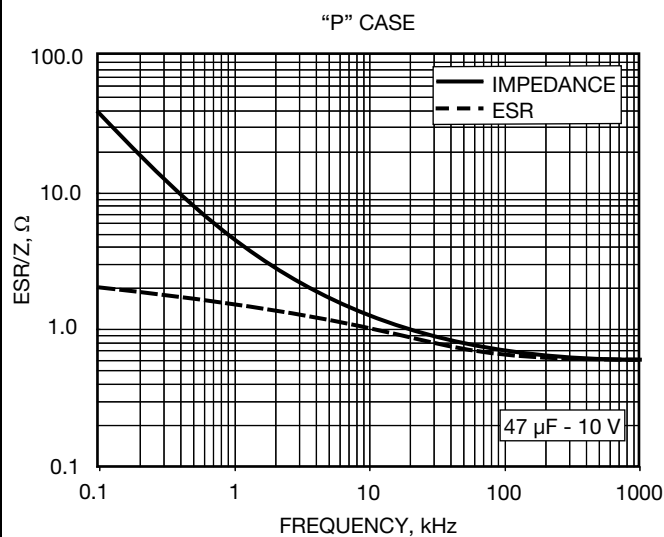
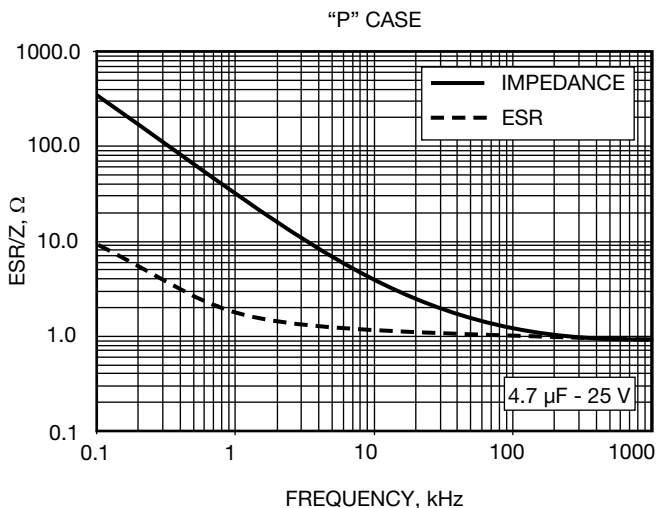
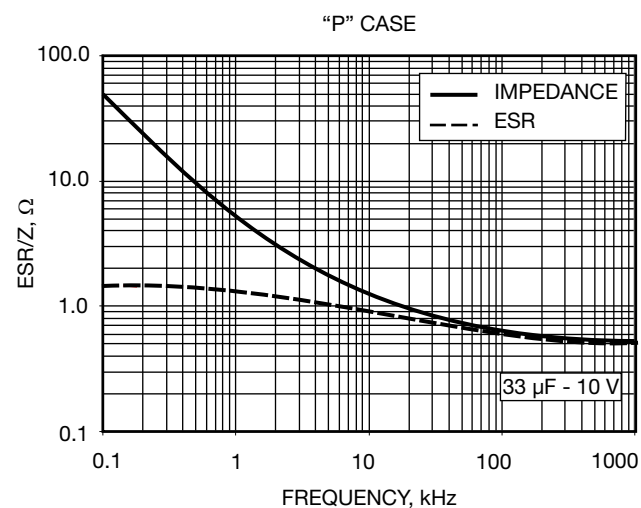
**ENVIRONMENTAL PERFORMANCE CHARACTERISTICS**

ITEM	CONDITION	POST TEST PERFORMANCE	
Life Test at + 85 °C	1000 h application of rated voltage at 85 °C with a 3 Ω series resistance, MIL-STD-202 method 108A	Capacitance change Dissipation factor Leakage current	$\pm 30 \%$ Not to exceed 150 % of initial Not to exceed 200 % of initial
Humidity Test	At 40 °C/90 % RH 500 h, no voltage applied. MIL-STD-202 method 103B	Capacitance change Dissipation factor Leakage current	$\pm 30 \%$ Not to exceed 150 % of initial Not to exceed 200 % of initial
Thermal Shock	At - 55 °C/+ 125 °C, 30 min each, for 5 cycles. MIL-STD-202 method 107G	Capacitance change Dissipation factor Leakage current	$\pm 30 \%$ Not to exceed 150 % of initial Not to exceed 200 % of initial

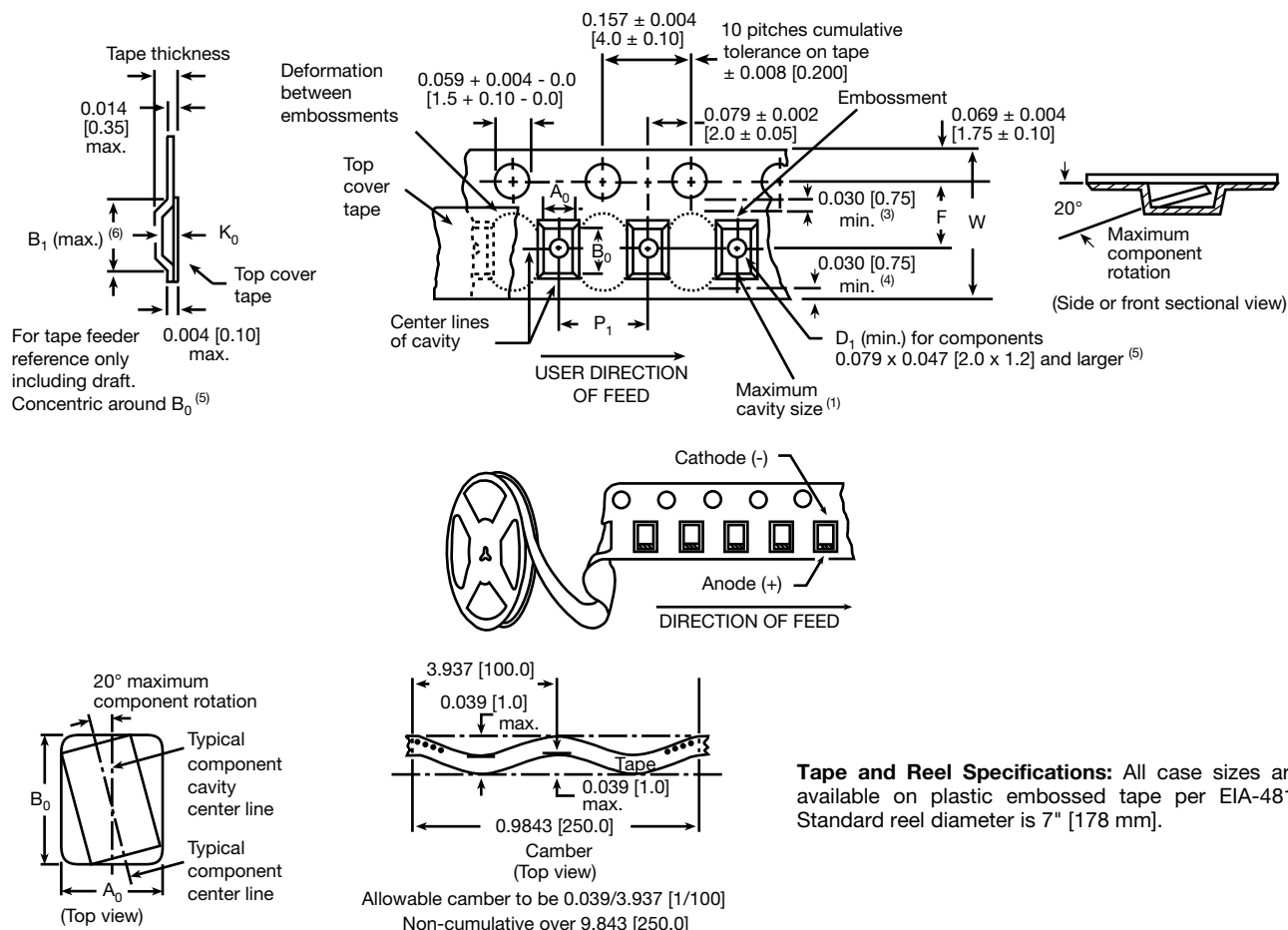
MECHANICAL PERFORMANCE CHARACTERISTICS

ITEM	CONDITION	POST TEST PERFORMANCE	
Terminal Strength	Apply a pressure load of 5 N for 10 s \pm 1 s horizontally to the center of capacitor side body. AEC Q-200 rev. C method 006	There shall be no visual damage when viewed at 20 x magnification and the component shall meet the original electrical requirements.	
Vibration	MIL-STD-202, method 204D, 10 Hz to 2000 Hz, 20 g peak	Capacitance change Dissipation factor Leakage current ESR	$\pm 10 \%$ Initial specified value or less Initial specified value or less Initial specified value or less There shall be no mechanical or visual damage to capacitors post-conditioning.
Shock	MIL-STD-202, method 213B, condition I, 100 g peak	Capacitance change Dissipation factor Leakage current ESR	$\pm 10 \%$ Initial specified value or less Initial specified value or less Initial specified value or less There shall be no mechanical or visual damage to capacitors post-conditioning.
Resistance to Solder Heat	MIL-STD-202, method 210F, condition K	Capacitance change Dissipation factor Leakage current	$\pm 30 \%$ Not to exceed 150 % of initial Not to exceed 200 % of initial There shall be no mechanical or visual damage to capacitors post-conditioning.
Solderability	MIL-STD-202, method 208H, ANSI/J-STD-002, Test B. Applies only to solder and tin plated terminations. Does not apply to gold terminations.	All terminations shall exhibit a continuous solder coating free from defects for a minimum of 95 % of the critical area of any individual lead.	
Resistance to Solvents	MIL-STD-202, method 215D	Marking has to remain legible, no degradation of encapsulation material.	
Flammability	Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 %		

TYPICAL CURVES AT + 25 °C, IMPEDANCE AND ESR VS. FREQUENCY


TYPICAL CURVES AT + 25 °C, IMPEDANCE AND ESR VS. FREQUENCY


PLASTIC TAPE AND REEL PACKAGING in inches [millimeters]

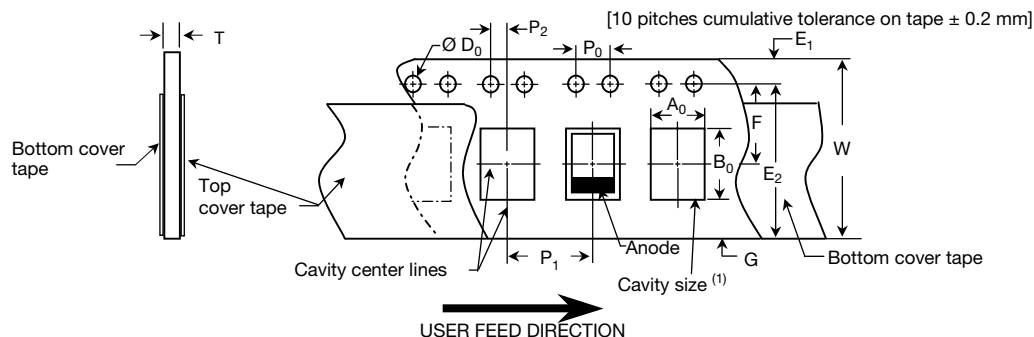


Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only.
- ⁽¹⁾ A_0 , B_0 , K_0 , are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A_0 , B_0 , K_0) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.
- ⁽²⁾ Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum.
- ⁽³⁾ This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less.
- ⁽⁴⁾ This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less.
- ⁽⁵⁾ The embossed hole location shall be measured from the sprocket hole controlling the location of the embossement. Dimensions of embossement location shall be applied independent of each other.
- ⁽⁶⁾ B_1 dimension is a reference dimension tape feeder clearance only.

CARRIER TAPE DIMENSIONS in inches [millimeters]

CASE CODE	TAPE SIZE	B_1 (MAX.)	D_1 (MIN.)	F	K_0 (MAX.)	P ₁	W
P, R	8 mm	0.108 [2.75]	0.039 [1.0]	0.138 ± 0.002 [3.5 ± 0.05]	0.054 [1.37]	0.157 ± 0.004 [4.0 ± 0.10]	0.315 + 0.0118/- 0.0039 [8.0 + 0.30/- 0.10]
A, Q	8 mm	0.165 [4.2]	0.039 [1.0]	0.138 ± 0.002 [3.5 ± 0.05]	0.094 [2.4]	0.157 ± 0.004 [4.0 ± 0.10]	0.315 ± 0.012 [8.0 ± 0.30]

PAPER TAPE AND REEL PACKAGING in inches [millimeters]


CASE SIZE	TAPE SIZE	A_0	B_0	D_0	P_0	P_1	P_2	E	F	W	T
K	8 mm	0.033 ± 0.002 [0.85 \pm 0.05]	0.053 ± 0.002 [1.35 \pm 0.05]	0.06 ± 0.004 [1.5 \pm 0.1]	0.157 ± 0.004 [4.0 \pm 0.1]	0.078 ± 0.004 [2.0 \pm 0.1]	0.079 ± 0.002 [2.0 \pm 0.05]	0.069 ± 0.004 [1.75 \pm 0.1]	0.0138 ± 0.002 [3.5 \pm 0.05]	0.315 ± 0.008 [8.0 \pm 0.2]	0.03 ± 0.002 [0.75 \pm 0.05]
M	8 mm	0.041 ± 0.002 [1.05 \pm 0.05]	0.071 ± 0.002 [1.8 \pm 0.05]	0.06 ± 0.004 [1.5 \pm 0.1]	0.157 ± 0.004 [4.0 \pm 0.1]	0.157 ± 0.004 [4.0 \pm 0.1]	0.079 ± 0.002 [2.0 \pm 0.05]	0.069 ± 0.004 [1.75 \pm 0.1]	0.0138 ± 0.002 [3.5 \pm 0.05]	0.315 ± 0.008 [8.0 \pm 0.2]	0.037 ± 0.002 [0.95 \pm 0.05]

Note

⁽¹⁾ A_0 , B_0 are determined by the maximum dimensions to the ends of the terminals extending from the component body and/or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A_0 , B_0) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.

STANDARD PACKAGING QUANTITY

CASE CODE	QUANTITY (pcs/reel)
	7" REEL
K	5000
M	4000
R	2500
P	3000
Q ⁽¹⁾	2500
A	2000
B ⁽¹⁾	2000

Note

⁽¹⁾ Preliminary values, contact factory for availability.

RECOMMENDED VOLTAGE DERATING GUIDELINES (for temperatures below + 85 °C)

STANDARD CONDITIONS. FOR EXAMPLE: OUTPUT FILTERS

Capacitor Voltage Rating	Operating Voltage
2.5	1.5
4.0	2.5
6.3	3.6
10	6.0
16	10
20	12
25	15
35	24
50	28

SEVERE CONDITIONS. FOR EXAMPLE: INPUT FILTERS

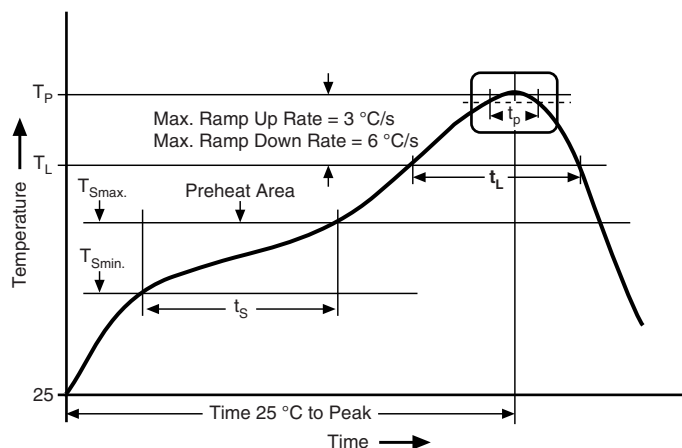
Capacitor Voltage Rating	Operating Voltage
2.5	1.5
4.0	2.5
6.3	3.3
10	5.0
16	8.0
20	10
25	12
35	15
50	24

**POWER DISSIPATION**

CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION AT + 25 °C (W) IN FREE AIR
K	0.015
M	0.025
R	0.045
P	0.045
Q ⁽¹⁾	0.055
A	0.075
B ⁽¹⁾	0.085

Note

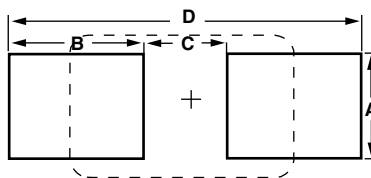
(1) Preliminary values, contact factory for availability.

RECOMMENDED REFLOW PROFILES

PROFILE FEATURE	SnPb EUTECTIC ASSEMBLY	LEAD (Pb)-FREE ASSEMBLY
PREHEAT AND SOAK		
Temperature min. ($T_{Smin.}$)	100 °C	150 °C
Temperature max. ($T_{Smax.}$)	150 °C	200 °C
Time (t_s) from ($T_{Smin.}$ to $T_{Smax.}$)	60 s to 90 s	60 s to 150 s
RAMP UP		
Ramp-up rate (T_L to T_p)	3 °C/s maximum	
Liquidous temperature (T_L)	183 °C	217 °C
Time (t_L) maintained above T_L	60 s to 150 s	
Peak package body temperature (T_p) max.	235 °C	260 °C
Time (t_p) within 5 °C of the peak max. temperature	20 s	30 s
RAMP DOWN		
Ramp-down rate (T_p to T_L)	6 °C/s maximum	
Time from 25 °C to peak temperature	6 min maximum	8 min maximum

Note

- Capacitors should withstand reflow profile as per J-STD-020 standard

PAD DIMENSIONS in inches [millimeters]


CASE CODE	A (MIN.)	B (NOM.)	C (NOM.)	D(NOM.)
K	0.028 [0.70]	0.018 [0.45]	0.024 [0.60]	0.059 [1.50]
M	0.039 [1.00]	0.028 [0.70]	0.024 [0.60]	0.080 [2.00]
R	0.059 [1.50]	0.031 [0.80]	0.039 [1.0]	0.102 [2.60]
P	0.063 [1.60]	0.031 [0.80]	0.047 [1.20]	0.110 [2.00]
Q ⁽¹⁾	0.071 [1.80]	0.067 [1.70]	0.053 [1.35]	0.187 [4.75]
A	0.071 [1.80]	0.067 [1.70]	0.053 [1.35]	0.187 [4.75]
B ⁽¹⁾	0.118 [3.00]	0.071 [1.80]	0.065 [1.65]	0.207 [5.25]

Note
⁽¹⁾ Preliminary values, contact factory for availability.

GUIDE TO APPLICATION

- AC Ripple Current:** The maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = Power dissipation in watts at + 25 °C (see paragraph number 5 and the table Power Dissipation)

R_{ESR} = The capacitor equivalent series resistance at the specified frequency

- AC Ripple Voltage:** The maximum allowable ripple voltage shall be determined from the formula:

$$V_{RMS} = Z \sqrt{\frac{P}{R_{ESR}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

P = Power dissipation in watts at + 25 °C (see paragraph number 5 and the table Power Dissipation)

R_{ESR} = The capacitor equivalent series resistance at the specified frequency

Z = The capacitor impedance at the specified frequency

- The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at + 25 °C.

- Reverse Voltage:** These capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at + 25 °C, 5 % of the DC rating at + 25 °C, 5 % of the DC rating at + 85 °C, and 1 % of the DC rating at + 125 °C.

- Temperature Derating:** If these capacitors are to be operated at temperatures above + 25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors as shown:

TEMPERATURE	DERATING FACTOR
+ 25 °C	1.0
+ 85 °C	0.9
+ 125 °C	0.4

- Power Dissipation:** Power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power Dissipation calculated using + 25 °C temperature rise.)

- Printed Circuit Board Materials:** Molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelainized steel).

- Attachment:**

- Solder Paste:** The recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.



- 7.2 **Soldering:** Capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time/temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 2 °C per s. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor.
- 7.2.1 **Backward and Forward Compatibility:** Capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.
8. **Cleaning (Flux Removal) After Soldering:** Molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chlorethane, Terpene and aqueous cleaning media. However, CFC/ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.
- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. DO NOT EXCEED 9W/l at 40 kHz for 2 min.
9. **Recommended Mounting Pad Geometries:** Proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and/or circuit board design.

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